VIII-4-1	Declaration: Inventorship (only for the purposes of the designation of the United States of America) Declaration of inventorship (Rules 4.17(iv) and 51bis.1(a)(iv)) for the purposes of the designation of the United States of America:	I hereby declare that I believe I am the original, first and sole (if only one inventor is listed below) or joint (if more than one inventor is listed below) inventor of the subject matter which is claimed and for which a patent is sought. This declaration is directed to the international application of which it forms a part (if filing declaration with application). I hereby declare that my residence, mailing address, and citizenship are as stated next to my name. I hereby state that I have reviewed and understand the contents of the
	Office States of America.	more than one inventor is listed below) inventor of the subject matter which is claimed and for which a patent is sought. This declaration is directed to the international application of which it forms a part (if filing declaration with application). I hereby declare that my residence, mailing address, and citizenship are as stated next to my name. I hereby state that I have reviewed and
VIII-4-1 -1	Prior applications:	60/370,496, US, 05 April 2002
		(05.04.2002)

I hereby acknowledge the duty to disclose information that is known by me to be material to patentability as defined by 37 C.F.R. § 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the PCT international filing date of the continuation-in-part application. I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

	Name:
-1-1	
VIII-4-1	Residence:
-1-2	(city and either US State, if applicable,
	or country)
VIII-4-1	Mailing address:
-1-3	
VIII-4-1	Citizenship:
-1-4	
VIII-4-1	Inventor's Signature:
-1-5	(if not contained in the request, or if
. •	declaration is corrected or added under
	Rule 26ter after the filing of the
	international application. The signature
	must be that of the inventor, not that of
	the agent)
VIII-4-1	Date:
-1-6	(of signature which is not contained in
-1-0	the request, or of the declaration that is
	corrected or added under Rule 26ter
	after the filing of the international
	application)

MA, Yue

West Windsor, New Jersey

6 Tiffany Ct.

US

5/14/03



VIII-4-1	Name:	CHANG, Chieh-Chung
-2-1		
VIII-4-1	Residence:	Monmouth Jct., New Jersey
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VIII-4-1 -2-3	Mailing address:	1702 Pheasant Run
VIII-4-1 -2-4	Citizenship:	TW
VIII-4-1 -2-5	Inventor's Signature: (if not contained in the request, or if declaration is corrected or added under Rule 26ter after the filing of the international application. The signature must be that of the inventor, not that of the agent)	Amholy Chen 5/20/03
VIII-4-1 -2-6	Date: (of signature which is not contained in the request, or of the declaration that is corrected or added under Rule 26ter after the filing of the international application)	·/
VIII-4-1	Name:	KAPLAN, Alan
-3-1	B14	
VIII-4-1 -3-2	Residence: (city and either US State, if applicable, or country)	Princeton, New Jersey
VIII-4-1 -3-3	Mailing address:	9 Erdman Ave.
VIII-4-1 -3-4	Citizenship:	us .
VIII-4-1 -3-5	Inventor's Signature: (if not contained in the request, or if declaration is corrected or added under Rule 26ter after the filing of the international application. The signature must be that of the inventor, not that of the agent)	alla
VIII-4-1 -3-6	Date: (of signature which is not contained in the request, or of the declaration that is corrected or added under Rule 26ter after the filing of the international application)	5/22/03